

# AON4420L 30V N-Channel MOSFET

General Description				Features				
The AON4420L cor technology with a s R <sub>DS(ON)</sub> per unit area and high speed swi	rovide low		30V 19mΩ 25mΩ	$(V_{GS} = 10)$ $(V_{GS} = 10)$ $(V_{GS} = 4)$	)V)			
- RoHS Col - Halogen F	•					Gr	een Product RoHS Compliant	
Top View	DFN 3x2 Botto	om View					γD	
			D D G		⊐ D ⊐ D ⊐ D ⊐ S	۲ ۱۹ ۵ ۲		
Absolute Maximum			D D G		D D	۲ میں ا		
			D D G		D D	_	Units	
Parameter	Ratings T <sub>A</sub> =2		D G G		⊐ D ⊐ D ⊐ S	_		
Parameter Drain-Source Voltage Gate-Source Voltage	Ratings T <sub>A</sub> =2		D G Otherwise Symbol		D D S Maximum	_	Units	
Parameter Drain-Source Voltage Gate-Source Voltage	Ratings T <sub>A</sub> =2		D G G Otherwise Symbol V <sub>DS</sub>		□ D □ D □ S Maximum 30	_	Units V	
Parameter Drain-Source Voltage Gate-Source Voltage Pulsed Drain Current Continuous Drain	Ratings T <sub>A</sub> =2		D G G Otherwise Symbol V <sub>DS</sub> V <sub>GS</sub>		□ D □ D □ S Maximum 30 ±20	_	Units V V	
Parameter Drain-Source Voltage Gate-Source Voltage Pulsed Drain Current Continuous Drain	Ratings T <sub>A</sub> =2		D G G Otherwise Symbol V <sub>DS</sub> V <sub>GS</sub>		□ D □ D □ S Maximum 30 ±20 50	_	Units V	
Parameter Drain-Source Voltage Gate-Source Voltage Pulsed Drain Current Continuous Drain Current <sup>A</sup>	Ratings $T_A=25$ c $T_A=25$ °C		D D G G Symbol V <sub>DS</sub> V <sub>GS</sub> I <sub>DM</sub> I <sub>D</sub>		□ D □ D □ S ■	_	Units V V A	
Parameter Drain-Source Voltage Gate-Source Voltage Pulsed Drain Current Continuous Drain Current <sup>A</sup>	Ratings $T_A=25$ c $T_A=25^{\circ}C$ $T_A=70^{\circ}C$		otherwise Symbol V <sub>DS</sub> V <sub>GS</sub> I <sub>DM</sub> P <sub>D</sub>		■ D ■ D ■ S ■ S ■ S ■ S ■ S ■ S ■ S ■ S ■ S ■ S	_	Units V V	
Parameter Drain-Source Voltage Gate-Source Voltage Pulsed Drain Current Continuous Drain Current <sup>A</sup> Power Dissipation <sup>A</sup>	Ratings $T_A=25^{\circ}$ C $T_A=25^{\circ}$ C $T_A=70^{\circ}$ C $T_A=70^{\circ}$ C $T_A=70^{\circ}$ C	5°C unless	D D G G Symbol V <sub>DS</sub> V <sub>GS</sub> I <sub>DM</sub> I <sub>D</sub>		□ D □ D □ S ■		Units V V A	
Parameter Drain-Source Voltage Gate-Source Voltage Pulsed Drain Current Continuous Drain Current <sup>A</sup> Power Dissipation <sup>A</sup> Junction and Storage	Ratings $T_A = 25^{\circ}$ C $T_A = 25^{\circ}$ C $T_A = 70^{\circ}$ C $T_A = 70^{\circ}$ C $T_A = 70^{\circ}$ CTemperature F	5°C unless	otherwise Symbol V <sub>DS</sub> V <sub>GS</sub> I <sub>DM</sub> P <sub>D</sub>		■ D ■ D ■ S ■ S ■ S ■ S ■ D ■ D ■ D ■ D ■ D ■ D ■ D ■ D ■ D ■ D		Units V V A W	
Parameter Drain-Source Voltage Gate-Source Voltage Pulsed Drain Current Continuous Drain Current <sup>A</sup> Power Dissipation <sup>A</sup> Junction and Storage	Ratings $T_A = 25^{\circ}$ C $T_A = 25^{\circ}$ C $T_A = 70^{\circ}$ C $T_A = 70^{\circ}$ C $T_A = 70^{\circ}$ CTemperature F	5°C unless	otherwise Symbol V <sub>DS</sub> V <sub>GS</sub> I <sub>DM</sub> P <sub>D</sub>		■ D ■ D ■ S ■ S ■ S ■ S ■ D ■ D ■ D ■ D ■ D ■ D ■ D ■ D ■ D ■ D		Units V V A W	
Absolute Maximum Parameter Drain-Source Voltage Gate-Source Voltage Pulsed Drain Current Continuous Drain Current <sup>A</sup> Power Dissipation <sup>A</sup> Junction and Storage Thermal Characteris Parameter Maximum Junction-to	Ratings $T_A=25$ C $T_A=25$ °C $T_A=70$ °C $T_A=70$ °C $T_A=70$ °C Temperature F Stics -Ambient <sup>A</sup>	5°C unless 5°C unless Range t ≤	D D G Otherwise Symbol V <sub>DS</sub> V <sub>GS</sub> I <sub>DM</sub> I <sub>D</sub> P <sub>D</sub> T <sub>J</sub> , T <sub>STG</sub> 10s	noted	□ D □ D □ S Maximum 30 ±20 50 10 8 1.6 1 -55 to 150		Units V V A W °C Units °C/W	
Parameter Drain-Source Voltage Gate-Source Voltage Pulsed Drain Current Continuous Drain Current <sup>A</sup> Power Dissipation <sup>A</sup> Junction and Storage Thermal Characteris Parameter	Ratings $T_A=24$ C $T_A=25^{\circ}C$ $T_A=70^{\circ}C$ $T_A=70^{\circ}C$ $T_A=70^{\circ}C$ Temperature F Stics -Ambient <sup>A</sup> -Ambient <sup>A</sup>	5°C unless 5°C unless Range Range	D D G G Symbol V <sub>DS</sub> V <sub>GS</sub> I <sub>DM</sub> I <sub>D</sub> P <sub>D</sub> TJ, T <sub>STG</sub>	noted	■ D ■ D ■ D ■ S Maximum 30 ±20 50 10 8 1.6 1 -55 to 150 Typ	Max	Units V V A W °C	



#### Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Тур	Max	Units
STATIC P	PARAMETERS					-	-
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0V$		30			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{\rm DS} = 30 \text{V},  V_{\rm GS} = 0 \text{V}$	T <sub>.1</sub> = 55°C			1 5	μA
I <sub>GSS</sub>	Gate-Body leakage current	$V_{DS} = 0V, V_{GS} = \pm 20V$	,			±100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS} I_D = 250 \mu A$		1.4	1.9	2.5	V
I <sub>D(ON)</sub>	On state drain current	$V_{GS} = 10V, V_{DS} = 5V$		50			А
R <sub>DS(ON)</sub>		$V_{GS} = 10V, I_{D} = 10A$			16	20	
	Static Drain-Source On-Resistance		T <sub>J</sub> =125°C		27		mΩ
		$V_{GS} = 4.5V, I_{D} = 8A$			21	26	
<b>g</b> <sub>FS</sub>	Forward Transconductance	$V_{DS} = 5V, I_{D} = 10A$			30		S
V <sub>SD</sub>	Diode Forward Voltage	$I_{S} = 1A, V_{GS} = 0V$			0.75	1	V
ls	Maximum Body-Diode Continuous Curr				3	A	
DYNAMIC	PARAMETERS					-	-
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> =0V, V <sub>DS</sub> =15V, f=1MHz		440	550	660	pF
C <sub>oss</sub>	Output Capacitance			80	110	140	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			35	55	80	pF
R <sub>g</sub>	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz		2	4	6	Ω
SWITCHI	NG PARAMETERS						
Q <sub>g</sub> (10V)	Total Gate Charge (10V)	V <sub>GS</sub> =10V, V <sub>DS</sub> =15V, I <sub>D</sub> =10A		8	9.8	12	nC
Q <sub>g</sub> (4.5V)	Total Gate Charge (4.5V)			4	4.6	5.5	nC
Q <sub>gs</sub>	Gate Source Charge			1.5	1.8	2.2	nC
$Q_{gd}$	Gate Drain Charge			1.3	2.2	3	nC
t <sub>D(on)</sub>	Turn-On DelayTime				5		ns
t <sub>r</sub>	Turn-On Rise Time	$V_{GS}$ =10V, $V_{DS}$ =15V, $R_{L}$ =1.5 $\Omega$ , $R_{GEN}$ =3 $\Omega$			3.2		ns
t <sub>D(off)</sub>	Turn-Off DelayTime				24		ns
t <sub>f</sub>	Turn-Off Fall Time	]			6		ns
t <sub>rr</sub>	Body Diode Reverse Recovery Time	$I_F$ =10A, dI/dt=300A/ $\mu$	S	8	11	14	ns
Q <sub>rr</sub>	Body Diode Reverse Recovery Charge	I <sub>F</sub> =10A, dI/dt=300A/μ	S	11	13	16	nC

A: The value of R <sub>eJA</sub> is measured with the device mounted on  $1in^2$  FR-4 board with 2oz. Copper, in a still air environment with T<sub>A</sub> = 25°C. The value in any given application depends on the user's specific board design.

B: Repetitive rating, pulse width limited by junction temperature.

C. The R  $_{\rm \theta JA}$  is the sum of the thermal impedence from junction to lead R  $_{\rm \theta JL}$  and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using t  $\leq$  300 µs pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^{\circ}$  C. The SOA curve provides a single pulse rating.

F. The current rating is based on the t  $\leq$  10s thermal resistance rating.

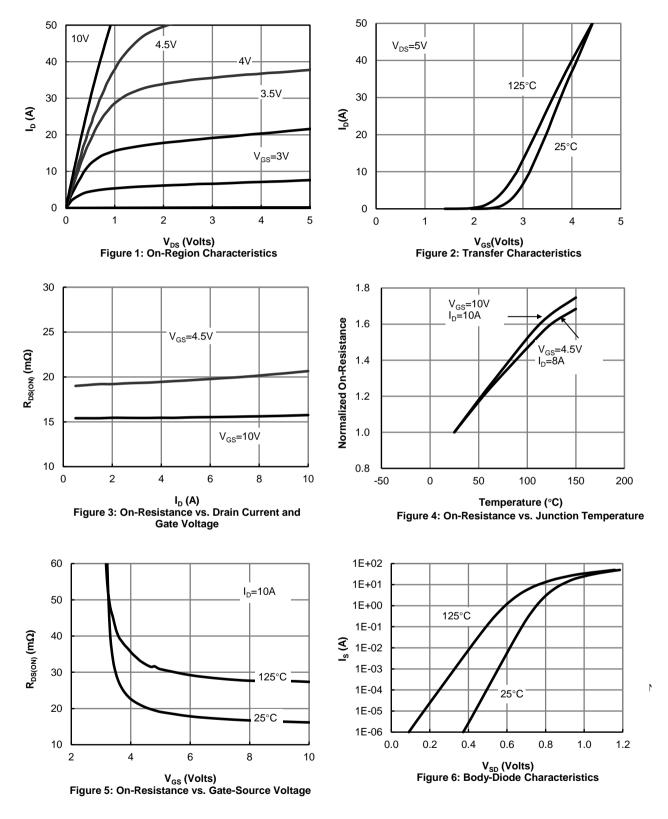
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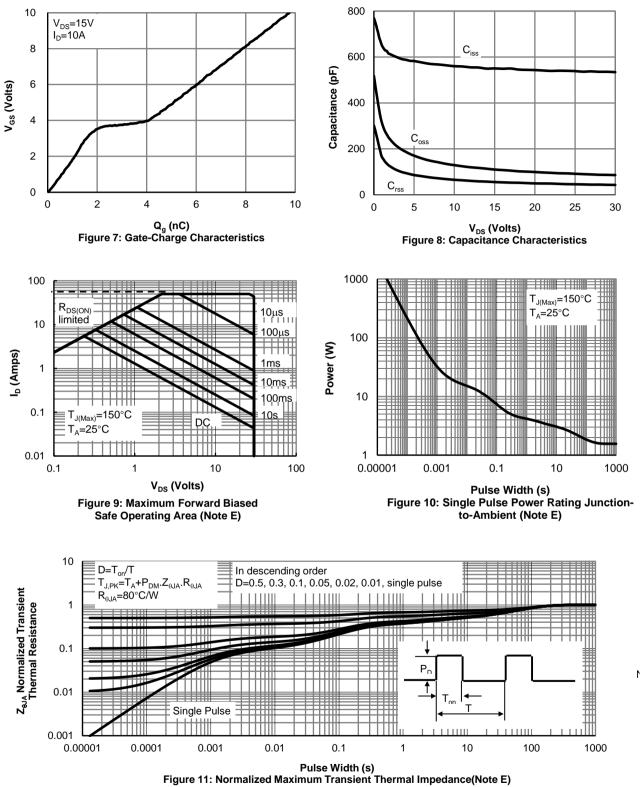


## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



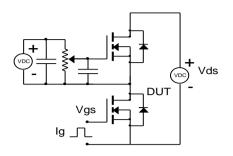


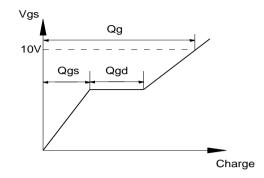
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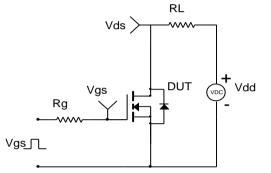


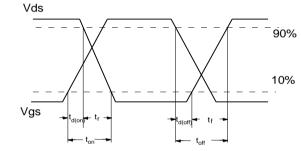
#### Gate Charge Test Circuit & Waveform





Resistive Switching Test Circuit & Waveforms





## Diode Recovery Test Circuit & Waveforms

